



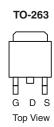
## N-Channel 100 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$				
100	0.0095 at V <sub>GS</sub> = 10 V	110 <sup>a</sup>			

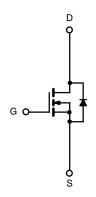
#### **FEATURES**

- TrenchFET® Power MOSFET
- New Package with Low Thermal Resistance
- 100 % R<sub>g</sub> Tested





Ordering Information: SUM110N10-09-E3 (Lead (Pb)-free)



N-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b> $T_C = 25$ °C, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V <sub>DS</sub>	100	V			
Gate-Source Voltage	$V_{GS}$	± 20	V			
Continuous Drain Current (T. – 175 °C)	T <sub>C</sub> = 25 °C	1	110 <sup>a</sup>	Α		
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 125 °C	- I <sub>D</sub>	87 <sup>a</sup>			
Pulsed Drain Current	I <sub>DM</sub>	440	A			
Avalanche Current	I <sub>AR</sub>	75				
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	280	mJ		
Marian Para Pinain atianh	T <sub>C</sub> = 25 °C	В	375 <sup>c</sup>	W		
Maximum Power Dissipation <sup>b</sup>	T <sub>A</sub> = 25 °C	$ P_D$	3.75	VV		
Operating Junction and Storage Temperatu	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Limit	Unit				
Junction-to-Ambient	R <sub>thJA</sub>	40	°C/W				
Junction-to-Case (Drain)	R <sub>thJC</sub>	0.4	C/VV				

#### Notes:

- a. Package limited.
- b. Duty cycle  $\leq$  1 %.
- c. See SOA curve for voltage derating.
  d. When mounted on 1" square PCB (FR-4 material).

## SUM110N10-09

## Vishay Siliconix



<b>SPECIFICATIONS</b> $T_J = 25^{\circ}$	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Oyillooi	rest conditions	.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	Typ.	wax.	Oilit	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{DS} = 0 \text{ V, } I_{D} = 250  \mu\text{A}$	100				
Gate-Threshold Voltage	-	$V_{DS} = V_{SS}, I_{D} = 250 \mu\text{A}$ $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2		4	V	
Gate-Body Leakage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, V_{DS} = 250 \text{ pA}$ $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$		1	± 100	nA	
Gate-Dody Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$ $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$		1	1	IIA	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = 100 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		1	50	μΑ	
Zero Gate Voltage Diam Current	I <sub>DSS</sub>	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ C}$ $V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			250		
On-State Drain Current <sup>a</sup>	1	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 173 \text{ C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120		250	Α	
On-State Drain Current	I <sub>D(on)</sub>		120	0.0070	0.0005	A	
Durin Course On Olate Business		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.0078	0.0095	_	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}, T_J = 125 ^{\circ}\text{C}$			0.017	Ω	
- IT I 3		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C			0.025		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	25			S	
Dynamic <sup>b</sup>	1			T	ı		
Input Capacitance	C <sub>iss</sub>			6700		pF	
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		750			
Reverse Transfer Capacitance	C <sub>rss</sub>			280			
Total Gate Charge <sup>c</sup>	$Q_g$			110	160	nC	
Gate-Source Charge <sup>c</sup>	$Q_{gs}$	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$		24			
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			24			
Gate Resistance	$R_{g}$		1.0		6.2	Ω	
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			20	30	ns ns	
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 50 \text{ V}, R_1 = 0.6 \Omega$		125	200		
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		55	85		
Fall Time <sup>c</sup>	t <sub>f</sub>			130	195		
Source-Drain Diode Ratings and Cha	aracteristics 7	Γ <sub>C</sub> = 25 °C <sup>b</sup>					
Continuous Current	I <sub>S</sub>				110		
Pulsed Current	I <sub>SM</sub>				240	Α	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 85 A, V <sub>GS</sub> = 0 V		1.0	1.5	V	
Reverse Recovery Time	t <sub>rr</sub>	. 35		70	140	ns	
Peak Reverse Recovery Charge	I <sub>RM(REC)</sub>	I <sub>F</sub> = 50 A, dl/dt = 100 A/μs		5.5	10	Α	
Reverse Recovery Charge	Q <sub>rr</sub>			0.19	0.35	μС	

#### Notes:

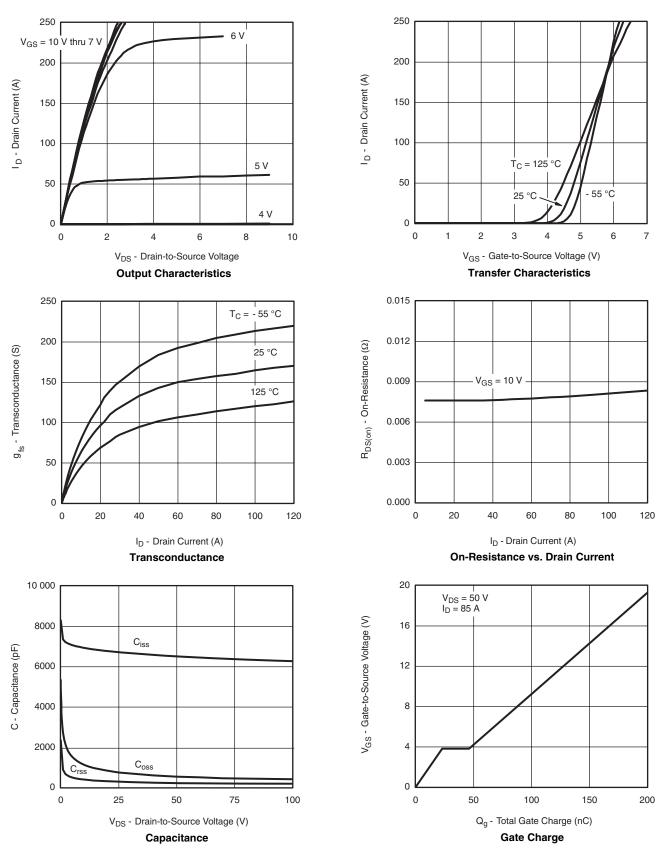
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.





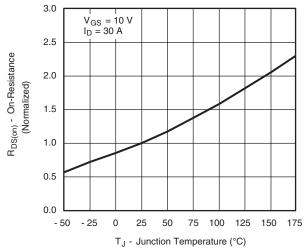
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



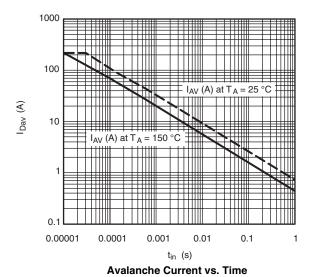
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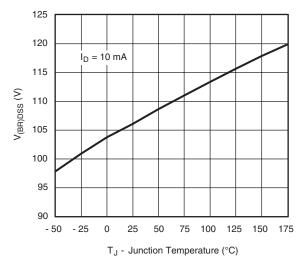
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### On-Resistance vs. Junction Temperature



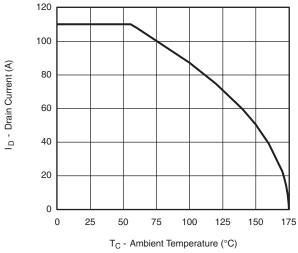
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



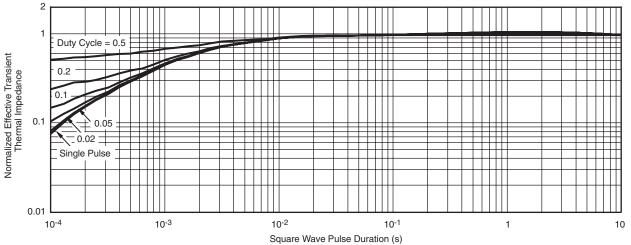
#### THERMAL RATINGS



1000 100 I<sub>D</sub> - Drain Current (A) Limited by R<sub>DS(on)\*</sub> 10 1 ms T<sub>C</sub> = 25 °C Single Pulse 0.1 0.1 10 1000 V<sub>DS</sub> - Drain-to-Source Voltage (V) \*  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

**Maximum Avalanche and Drain Current** vs. Case Temperature



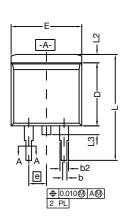


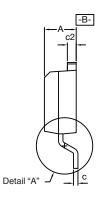
Normalized Thermal Transient Impedance, Junction-to-Case

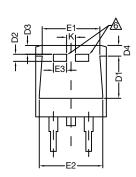
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## TO-263 (D<sup>2</sup>PAK): 3-LEAD









DETAIL A (ROTATED 90°)



_	,	— t   <del></del> b	1-		
2	T			5	
	QE	ΩTΙ(	)N	<u>1</u> ۸-7	( †

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. \*: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6 This feature is for thick lead.

DIM.		INC	HES	MILLIMETERS		
		MIN.	MAX.	MIN.	MAX.	
Α		0.160	0.190	4.064	4.826	
	b	0.020	0.039	0.508	0.990	
	b1	0.020	0.035	0.508	0.889	
	b2	0.045	0.055	1.143	1.397	
c*	Thin lead	0.013	0.018	0.330	0.457	
	Thick lead	0.023	0.028	0.584	0.711	
c1	Thin lead	0.013	0.017	0.330	0.431	
CI	Thick lead	0.023	0.027	0.584	0.685	
	c2	0.045	0.055	1.143	1.397	
	D	0.340	0.380	8.636	9.652	
	D1	0.220	0.240	5.588	6.096	
	D2	0.038	0.042	0.965	1.067	
	D3	0.045	0.055	1.143	1.397	
	D4	0.044	0.052	1.118	1.321	
	Е	0.380	0.410	9.652	10.414	
	E1	0.245	-	6.223	-	
E2		0.355	0.375	9.017	9.525	
	E3	0.072	0.078	1.829	1.981	
	е	0.100	BSC	2.54 BSC		
K		0.045	0.055	1.143	1.397	
L		0.575	0.625	14.605	15.875	
L1		0.090	0.110	2.286	2.794	
	L2	0.040	0.055	1.016	1.397	
L3		0.050	0.070	1.270	1.778	
L4		0.010 BSC		0.254 BSC		
М		-	0.002	-	0.050	
ECN: T13-0707-Rev. K, 30-Sep-13						

DWG: 5843





#### RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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